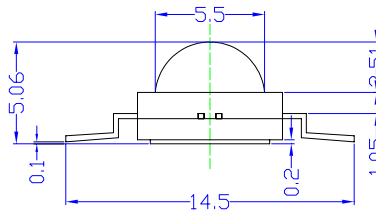
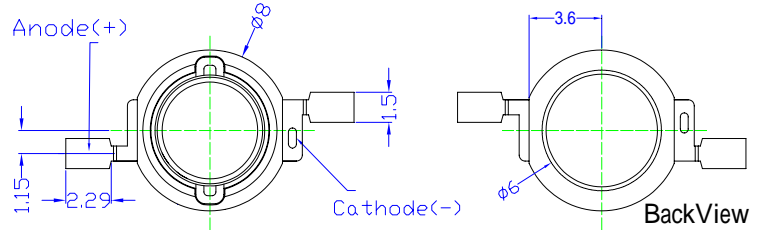


**■Features**

- Highest Luminous Flux
- Super Energy Efficiency
- Long Lifetime Operation
- Superior UV Resistance

**■Outline Dimension**



Unit:mm  
Tolerance:±0.30mm

Tolerances are for reference only

**■Applications**

- Read lights (car, bus, aircraft)
- Portable (flashlight, bicycle)
- Bollards / Security / Garden
- Traffic signaling / Beacons
- In door / Out door Commercial lights
- Automotive Ext

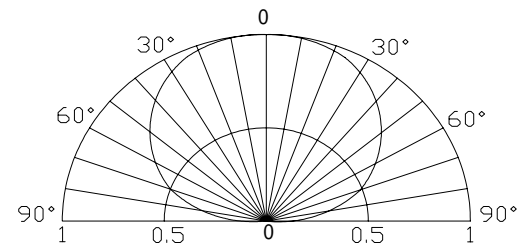
**■Absolute Maximum Rating**

(Ta=25 °C)

Item	Symbol	Value	Unit
DC Forward Current	I <sub>F</sub>	30	mA
Pulse Forward Current*	I <sub>FP</sub>	50	mA
Reverse Voltage	V <sub>R</sub>	25	V
Power Dissipation	P <sub>D</sub>	660	mW
Operating Temperature	T <sub>opr</sub>	-30 ~ +85	
Storage Temperature	T <sub>stg</sub>	-40~ +100	
Lead Soldering Temperature	T <sub>sol</sub>	260 /5sec	-

\*Pulse width Max.10ms Duty ratio max 1/10

**■Directivity**

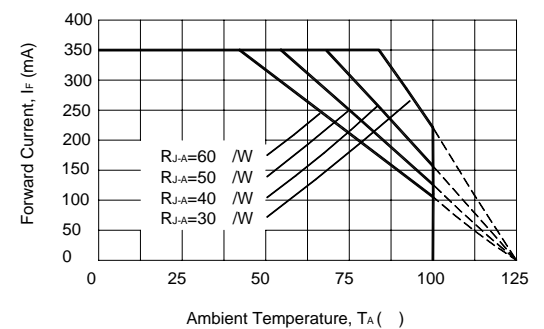


**■Electrical -Optical Characteristics**

(Ta=25 °C)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
DC Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =30mA	18	20	22	V
DC Reverse Current	I <sub>R</sub>	V <sub>R</sub> =25V	-	-	10	μA
Luminous Flux	v	I <sub>F</sub> =30mA	60	75	-	lm
Color Temperature	CCT	I <sub>F</sub> =30mA	-	6500	-	K
Chromaticity Coordinates*	x	I <sub>F</sub> =30mA	-	0.31	-	-
	y	I <sub>F</sub> =30mA	-	0.33	-	-
50% Power Angle	2θ <sub>1/2</sub>	I <sub>F</sub> =30mA	-	140	-	deg

**■Forward Operating Current (DC)**



Note: Don't drive at rated current more than 5s without heat sink for Xeon 1 emitter series.

■ **Soldering Heat Reliability (DIP):**

Reflow soldering Profile

- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the **characteristics of the LEDs will or will not be damaged by repairing.**

<b>Solder</b>
Average ramp-up rate = 3°C/sec. max.
Preheat temperature: 150°~180°C
Preheat time = 120 sec. max.
Ramp-down rate = 6°C/sec. max.
Peak temperature = 220°C max.
Time within 3°C of actual peak temperature = 25 sec. max.
Duration above 200°C is 40 sec. max.

